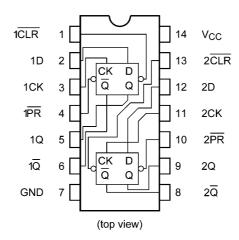
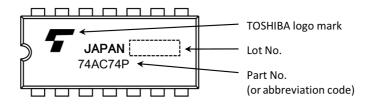


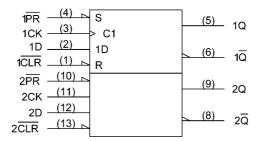
5. Pin Assignment



6. Marking



7. IEC Logic Symbol



8. Truth Table

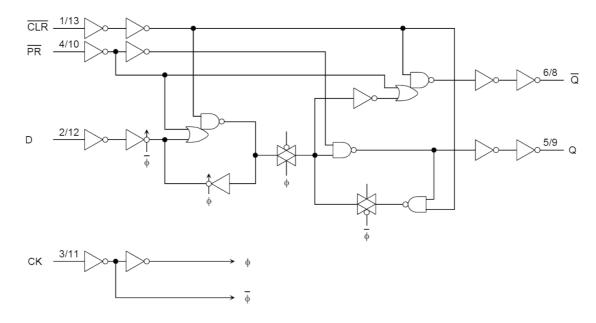
	Inp	uts		Out	puts	Function	
CLR	PR	D	СК	Q	IQ	Function	
L	Ι	Х	Х	L	Н	Clear	
Н	L	Х	Х	Н	L	Preset	
L	L	Х	Х	Н	Н	_	
Н	Ι	L		L	Н		
Н	Η	Н		Н	L	_	
Н	Н	Х		Qn	- Qn	No Change	

X: Don't care

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9. System Diagram



10. Absolute Maximum Ratings (Note)

Characteristics	Symbol	Note	Rating	Unit
Supply voltage	V _{CC}		-0.5 to 7.0	V
Input voltage	V _{IN}		-0.5 to V _{CC} + 0.5	V
Output voltage	V _{OUT}		-0.5 to V _{CC} + 0.5	V
Input diode current	I _{IK}		±20	mA
Output diode current	I _{OK}		±50	mA
Output current	I _{OUT}		±50	mA
V _{CC} /ground current	Icc		±100	mA
Power dissipation	P _D	(Note 1)	500	mW
Storage temperature	T _{stg}		-65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: 500 mW in the range of T_a = -40 to 65°C. From T_a = 65 to 85°C a derating factor of -10 mW/°C shall be applied until 300 mW.

11. Operating Ranges (Note)

Characteristics	Symbol	Test Condition	Rating	Unit
Supply voltage	V _{CC}		2.0 to 5.5	V
Input voltage	V _{IN}		0 to V _{CC}	V
Output voltage	V _{OUT}		0 to V _{CC}	V
Operating temperature	T _{opr}		-40 to 85	°C
Input rise and fall times	dt/dv	V_{CC} = 3.3 ± 0.3 V	0 to 100	ns/V
		V _{CC} = 5.0 ± 0.5 V	0 to 20	1

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either V_{CC} or GND.

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12. Electrical Characteristics

12.1. DC Characteristics (Unless otherwise specified, T_a = 25 °C)

Characteristics	Symbol	Test Condition	١	V _{CC} (V)	Min	Тур.	Max	Unit
High-level input voltage	V _{IH}	_		2.0	1.50		_	V
				3.0	2.10	_	_	
				5.5	3.85	_	_	
Low-level input voltage	V _{IL}	_		2.0	_	_	0.50	V
				3.0	_	_	0.90	
				5.5			1.65	
High-level output voltage	V _{OH}	V _{IN} = V _{IH} or V _{IL}	I _{OH} = -50 μA	2.0	1.9	2.0	_	V
				3.0	2.9	3.0	_	
				4.5	4.4	4.5	_	
			I _{OH} = -4 mA	3.0	2.58	_	_	
			I _{OH} = -24 mA	4.5	3.94	_	_	
Low-level output voltage	V _{OL}	V _{IN} = V _{IH} or V _{IL}	I _{OL} = 50 μA	2.0	_	0.0	0.1	V
				3.0	_	0.0	0.1	
				4.5	_	0.0	0.1	
			I _{OL} = 12 mA	3.0	_	_	0.36	
			I _{OL} = 24 mA	4.5	_	_	0.36	
Input leakage current	I _{IN}	V _{IN} = V _{CC} or GND	_	5.5	_	_	±0.1	μΑ
Quiescent supply current	I _{CC}	$V_{IN} = V_{CC}$ or GND		5.5	_	_	4.0	μА

12.2. DC Characteristics (Unless otherwise specified, T_a = -40 to 85 °C)

Characteristics	Symbol	Test Condition	n	Note	V _{CC} (V)	Min	Max	Unit
High-level input voltage	V _{IH}	_			2.0	1.50	_	V
					3.0	2.10	_	
					5.5	3.85	_	
Low-level input voltage	V _{IL}	_			2.0	_	0.50	V
					3.0		0.90	
					5.5		1.65	
High-level output voltage	V _{OH}	V _{IN} = V _{IH} or V _{IL}	I _{OH} = -50 μA		2.0	1.9	_	V
					3.0	2.9	_	
					4.5	4.4	_	
			I _{OH} = -4 mA		3.0	2.48	_	
			I _{OH} = -24 mA		4.5	3.80	_	
			I _{OH} = -75 mA	(Note 1)	5.5	3.85	_	
Low-level output voltage	V _{OL}	V _{IN} = V _{IH} or V _{IL}	I _{OL} = 50 μA		2.0	_	0.1	V
					3.0	_	0.1	
					4.5		0.1	
			I _{OL} = 12 mA		3.0	_	0.44	
			I _{OL} = 24 mA		4.5	_	0.44	
			I _{OL} = 75 mA	(Note 1)	5.5	_	1.65	
Input leakage current	I _{IN}	V _{IN} = V _{CC} or GND			5.5	_	±1.0	μΑ
Quiescent supply current	Icc	V _{IN} = V _{CC} or GND			5.5		40.0	μΑ

Note 1: This spec indicates the capability of driving 50 Ω transmission lines. One output should be tested within a 10 ms maximum duration.



12.3. Timing Requirements (Unless otherwise specified, $T_a = 25$ °C, Input: $t_f = t_f = 3$ ns)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Limit	Unit
Minimum pulse width	$t_{w(L)}, t_{w(H)}$	C _L = 50 pF	3.3 ± 0.3	7.0	ns
(CK)		$R_L = 500 \Omega$	5.0 ± 0.5	5.0	
Minimum pulse width	t _{w(L)}	C _L = 50 pF	3.3 ± 0.3	7.0	ns
(CLR, PR)		$R_L = 500 \Omega$	5.0 ± 0.5	5.0	
Minimum setup time	t _s	C _L = 50 pF	3.3 ± 0.3	6.0	ns
		$R_L = 500 \Omega$	5.0 ± 0.5	3.5	
Minimum hold time	t _h	C _L = 50 pF	3.3 ± 0.3	1.0	ns
		$R_L = 500 \Omega$	5.0 ± 0.5	1.0	
Minimum removal time	t _{rem}	C _L = 50 pF	3.3 ± 0.3	4.0	ns
(CLR, PR)		$R_L = 500 \Omega$	5.0 ± 0.5	2.0	

12.4. Timing Requirements (Unless otherwise specified, T_a = -40 to 85°C, Input: t_r = t_f = 3 ns)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Limit	Unit
Minimum pulse width	$t_{w(L)}, t_{w(H)}$	C _L = 50 pF	3.3 ± 0.3	7.0	ns
(CK)		$R_L = 500 \Omega$	5.0 ± 0.5	5.0	
Minimum pulse width	t _{w(L)}	C _L = 50 pF	3.3 ± 0.3	7.0	ns
(CLR, PR)		$R_L = 500 \Omega$	5.0 ± 0.5	5.0	
Minimum setup time	t _s	C _L = 50 pF	3.3 ± 0.3	6.0	ns
		$R_L = 500 \Omega$	5.0 ± 0.5	3.5	
Minimum hold time	t _h	C _L = 50 pF	3.3 ± 0.3	1.0	ns
		$R_L = 500 \Omega$	5.0 ± 0.5	1.0	
Minimum removal time	t _{rem}	C _L = 50 pF	3.3 ± 0.3	4.0	ns
(CLR, PR)		$R_L = 500 \Omega$	5.0 ± 0.5	2.0	



12.5. AC Characteristics (Unless otherwise specified, $T_a = 25$ °C, Input: $t_r = t_f = 3$ ns)

Characteristics	Symbol	Note	Test Condition	V _{CC} (V)	Min	Тур.	Max	Unit
Propagation delay time	t _{PLH} ,t _{PHL}		C _L = 50 pF	3.3 ± 0.3		8.2	13.9	ns
(CK-Q, Q)			$R_L = 500 \Omega$	5.0 ± 0.5		6.1	8.7	
Propagation delay time	t _{PLH} ,t _{PHL}		C _L = 50 pF	3.3 ± 0.3		8.0	13.1	ns
$(\overline{CLR}, \overline{PR}-Q, \overline{Q})$			$R_L = 500 \Omega$	5.0 ± 0.5	ı	5.7	8.2	
Maximum clock frequency	f _{MAX}		C _L = 50 pF	3.3 ± 0.3	60	120	_	MHz
			$R_L = 500 \Omega$	5.0 ± 0.5	100	160	_	
Input capacitance	C _{IN}					5	10	pF
Power dissipation capacitance	C _{PD}	(Note 1)				77	-	pF

Note 1: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation.

 $I_{CC(opr)} = C_{PD} \times V_{CC} \times f_{IN} + I_{CC}/2 \text{ (per F/F)}$

12.6. AC Characteristics

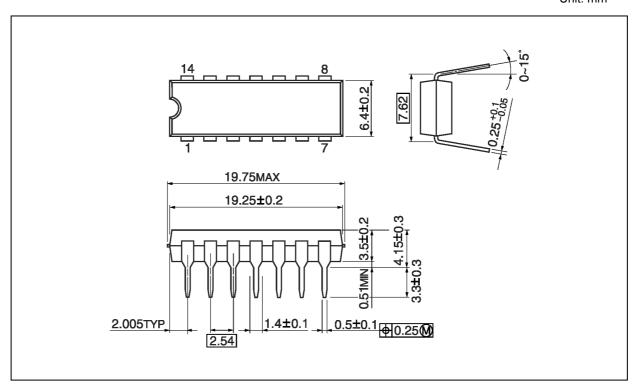
(Unless otherwise specified, $T_a = -40$ to 85 °C, Input: $t_r = t_f = 3$ ns)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Min	Max	Unit
Propagation delay time	t _{PLH} ,t _{PHL}	C _L = 50 pF	3.3 ± 0.3	1.0	16.0	ns
(CK-Q, Q)		$R_L = 500 \Omega$	5.0 ± 0.5	1.0	10.0]
Propagation delay time	t _{PLH} ,t _{PHL}	C _L = 50 pF	3.3 ± 0.3	1.0	15.0	ns
$(\overline{CLR}, \overline{PR}-Q, \overline{Q})$		$R_L = 500 \Omega$	5.0 ± 0.5	1.0	9.4	
Maximum clock frequency	f _{MAX}	C _L = 50 pF	3.3 ± 0.3	60	_	MHz
		$R_L = 500 \Omega$	5.0 ± 0.5	100	_	
Input capacitance	C _{IN}	_		_	10	pF



Package Dimensions

Unit: mm



Weight: 0.96 g (typ.)

	Package Name(s)
Nickname: DIP14	



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